

**General Description**

The CMSA90N03 is a high performance trench N-channel MOSFET which utilizes extremely high cell density to provide low Rdson and gate charge characteristics. It is ideally suited to support synchronous buck converter applications.

**Product Summary**

<b>BVDSS</b>	<b>RDS<sub>ON</sub></b>	<b>ID</b>
30V	3.8mΩ	90A

**Applications**

- On board power for server
- Power management for high performance computing
- High-efficiency DC-DC converters
- Synchronous rectification

**DFN-8 5x6 Pin Configuration****Features**

- Fast switching
- Super Low Gate Charge
- 100% avalanche tested
- RoHS Compliant

**Absolute Maximum Ratings**

<b>Symbol</b>	<b>Parameter</b>	<b>Rating</b>	<b>Units</b>
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D @ T_c = 25^\circ C$	Continuous Drain Current	90	A
$I_{DM}$	Pulsed Drain Current	270	A
EAS	Single Pulse Avalanche Energy <sup>1</sup>	750	mJ
$P_D @ T_c = 25^\circ C$	Total Power Dissipation	50	W
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

**Thermal Data**

<b>Symbol</b>	<b>Parameter</b>	<b>Typ.</b>	<b>Max.</b>	<b>Unit</b>
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	---	30	°C/W
$R_{\theta JC}$	Thermal Resistance Junction -Case	---	2.5	°C/W

Electrical Characteristics ( $T_J=25^\circ\text{C}$  , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=250\mu\text{A}$	30	---	---	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=20\text{A}$	---	---	3.8	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=20\text{A}$	---	---	5.5	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_{\text{D}}=250\mu\text{A}$	1	---	2.5	V
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=24\text{V}$ , $V_{\text{GS}}=0\text{V}$	---	---	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=5\text{V}$ , $I_{\text{D}}=15\text{A}$	---	60	---	S
$R_{\text{g}}$	Gate Resistance	$V_{\text{DS}}=0\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	5.5	---	$\Omega$
$Q_{\text{g}}$	Total Gate Charge	$V_{\text{DS}}=15\text{V}$ , $I_{\text{D}}=20\text{A}$	---	30	---	nC
$Q_{\text{gs}}$	Gate-Source Charge		---	5	---	
$Q_{\text{gd}}$	Gate-Drain Charge		---	15	---	
$T_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_{\text{G}}=3.3\Omega$	---	12	---	ns
$T_{\text{r}}$	Rise Time		---	8	---	
$T_{\text{d(off)}}$	Turn-Off Delay Time		---	50	---	
$T_{\text{f}}$	Fall Time		---	23	---	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	3400	---	pF
$C_{\text{oss}}$	Output Capacitance		---	415	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	350	---	

## Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_{\text{S}}$	Diode continuous forward current	$V_{\text{G}}=V_{\text{D}}=0\text{V}$ , Force Current	---	---	90	A
$I_{\text{S,pulse}}$	Diode pulse current		---	---	270	A
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{F}}=20\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1.2	V

## Notes

1. The test condition is  $V_{\text{DS}}=15\text{V}$  ,  $V_{\text{GS}}=10\text{V}$  ,  $L=0.5\text{mH}$  ,  $I_{\text{D}}=55\text{A}$ .

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